

TAS5162DKD6EVM

This user's guide describes the operation of the evaluation module for the TAS5162 Digital Amplifier Power Output Stage using the TAS5518 Digital Audio PWM Processor from Texas Instruments. The user's guide also provides measurement data and design information such as the schematic, BOM, and PCB layout

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Trademarks

PurePath Digital, Equibit are trademarks of Texas Instruments.

I²C is a trademark of Philips Electronics.

1 Overview

The TAS5162DKD6EVM PurePath Digital™ customer evaluation module demonstrates the integrated circuits TAS5162DKD and TAS5518PAG from Texas Instruments.

The TAS5162DKD is a high-performance, integrated stereo Digital Amplifier Power Stage designed to drive 6-Ω speakers at up to 210 W per channel. The device incorporates PurePath Digital™ technology and is designed to be used with PurePath Digital™ modulators. This system requires only a simple passive demodulation filter to deliver high-quality, high-efficiency audio amplification.

TAS5518PAG is a high performance 32 bit (24 bit input) multi channel PurePath Digital™ Pulse Width Modulator (PWM) based on Equibit™ technology with fully symmetrical AD modulation scheme. The device also has Digital Audio Processing (DAP) that provides 48 bit signal processing, advanced performance and a high level of system integration. The device has interfaces for headphone output and Power Supply Volume Control (PSVC).

This EVM is configured with 4 BTL channels and 1 PBTL (parallel BTL) channel for the subwoofer channel.

This EVM, together with a TI input-USB board, is a complete 5 channels + subwoofer line output digital audio amplifier system which includes digital input (S/PDIF), analog inputs, interface to PC and DAP features like digital volume control, input and output mixers, automute, tone controls, loudness, EQ filters and dynamic range compression (DRC). There are configuration options for power stage failure protection, and a phono connector for subwoofer line output.

Table 1. TAS5162DKD6EVM Specification

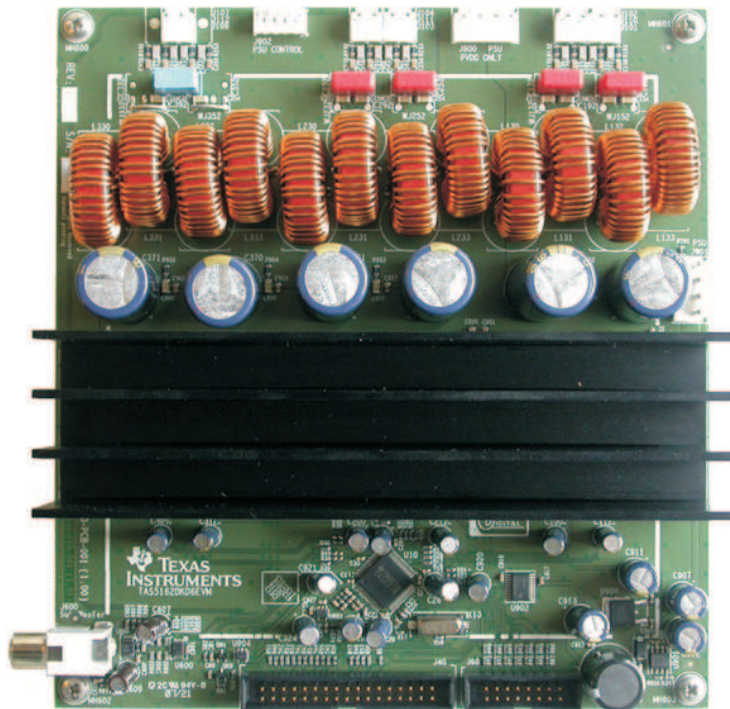
Key Parameters	
Output Stage Supply Voltage:	0 V - 50 V
System Supply Voltage:	15 V - 20 V
Number of Channels	4 x BTL, 1x PBTL
Load Impedance BTL:	6-8 Ω
Load Impedance PBTL:	4-8 Ω
Output power BTL	160 W / 8 Ω 10% THD or 210 W / 6 Ω / 10% THD
Output power PBTL	310 W / 4 Ω / 10% THD
DNR	>110 dB
PWM Processor	TAS5518PAG
Output Stage	TAS5162DKD

Table 1. TAS5162DKD6EVM Specification (continued)

Other Features	Subwoofer line output
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This 5 channel system + subwoofer line output is designed for home theater applications such as A/V receivers, DVD receivers, DVD mini-component systems or home theater in a box (HTIB).

This document covers EVM specifications, audio performance and power efficiency measurements graphs, and design documentation that includes schematics, parts list, layout and mechanical design.



Gerber (layout) files are available at www.ti.com.

The EVM is delivered with cables and Input-USB board to connect to an input source and be controlled from a PC.

1.1 1.1 TAS5162DKD6EVM Features

- 5/6 channel PurePath Digital™ evaluation module (double-sided plated-through PCB layout).
- Subwoofer Line Output (LFE Output).
- Self-contained protection system (short-circuit and thermal).
- Standard I²S and I²C™ / Control connector for TI input board
- Double-sided plated-through PCB layout.

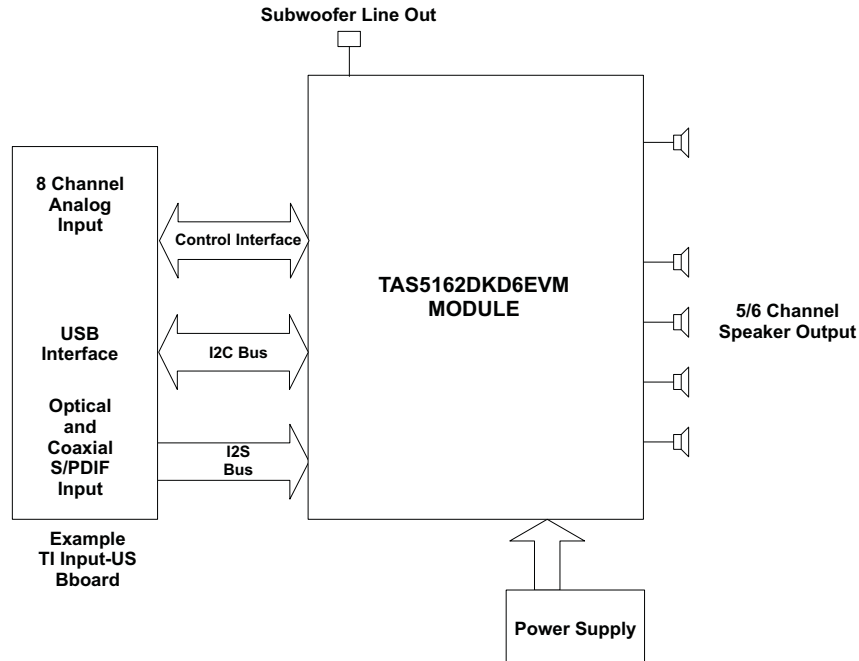


Figure 1. Integrated PurePath Digital™ Amplifier System

1.2 PCB Key Map

Physical structure for the TAS5162DKD6EVM is illustrated in Figure 2.

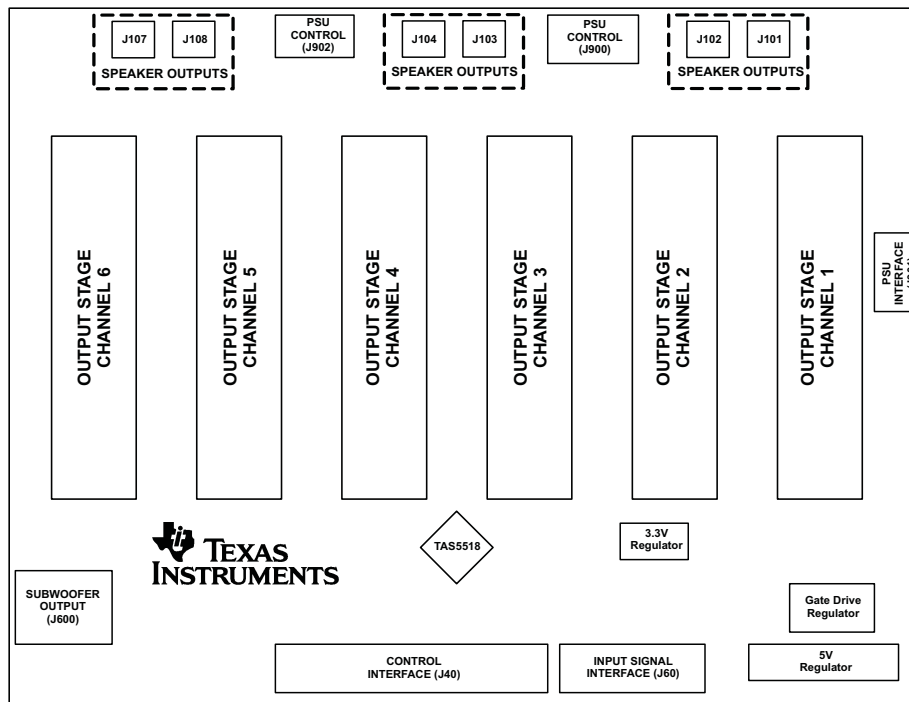


Figure 2. Physical structure for the TAS5162DKD6EVM (Approximate Layout)

2 Quick Setup Guide

This section describes the TAS5162DKD6EVM board in regards to power supplies and system interfaces. The section provides information regarding handling and unpacking, absolute operating conditions, and a description of the factory default switch and jumper configuration.

This chapter provides a step-by-step guide to configuring the TAS5162DKD6EVM for device evaluation.

2.1 Electrostatic Discharge Warning

Many of the components on the TAS5162DKD6EVM are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

CAUTION

Failure to observe ESD handling procedures may result in damage to EVM components.

2.2 Unpacking the EVM

Upon opening the TAS5162DKD6EVM package, check to make sure that the following items are included:

- 1 pc. TAS5162DKD6EVM board using one TAS5518PAG and four TAS5162DKD.
- 1 pc. TI Input-USB board for interfacing TAS5162DKD6EVM with SPDIF/analog sources and PC for control.
- 1 pc. Signal Interface IDC cable for connection to an I²S front-end like the attached TI Input-USB board.
- 1 pc. Control Interface IDC cable for connection to an I²C™ front-end like the attached TI Input-USB board.
- 1 pc Cable for connecting Input-USB board to a USB port on a PC for TAS5518 control by software.
- 1 pc. Power supply cable for one regulated power supply (H-bridge).
- 1 pc. Power supply cable for two regulated power supplies (H-bridge and System supply).
- 1 pc. PurePath™ CD-ROM

If any of these items are missing, contact the Texas Instruments Product Information Center nearest you to inquire about a replacement.

Connect the Input-USB board to TAS5162DKD6EVM using the 2 delivered IDC cables.

2.3 Power Supply Setup

To power up the EVM, two power supplies are needed. One for system power, logic and gate-drive, and one for output stage supply. Power supplies are connected to the EVM using delivered power cable Red/Black, White/Black.

Table 2. Recommended Supply Voltages

Description	Voltage Limitations	Current Requirement	Cable
System power supply	15 - 20 V	0.3 A	Red/Black
Output stage power supply	0 - 50 V	10 A	White/Black

CAUTION

Applying voltages above the limitations given in [Table 2](#) may cause permanent damage to the hardware.

Note: The length of power supply cable must be minimized. Increasing length of PSU cable is equal to increasing the distortion for the amplifier at high output levels and low frequencies.

2.4 Speaker Connection

CAUTION

Both positive and negative speaker outputs are floating and may not be connected to ground (e.g. through an oscilloscope).

2.5 GUI Software Installation

The TAS5518 GUI provides easy control of all registers in the TAS5518. To install the GUI, run setup file from the PurePath™ CD-ROM.

After installation, turn on the power supplies and connect the USB cable to the Input-USB board.

Start GUI program from windows menu. Start up of GUI will take few seconds.



Figure 3. TAS5518 GUI Window

From the files menu load the configuration file:

TAS5162DKD6EVM Configuration (1.00).cfg

The file is located on the PurePath™ CD-rom. This file contains all settings for a default setup of the EVM.

For easy access of the file it is recommended to copy the files into directory where the GUI is installed. Default is C:\Program Files\Texas Instruments Inc\TAS5518\

For more advanced use of the GUI, refer to the GUI User's Guide and data manual for the TAS5518.

3 Protection

This chapter describes the short-circuit protection and fault reporting circuitry of the TAS5162 ([SLES194](#)) device.

3.1 Short-Circuit Protection and Fault Reporting Circuitry

The TAS5162 is a self-protecting device that provides fault reporting (including high-temperature protection and short-circuit protection). TAS5162 is configured in back-end auto-recovery mode, and therefore, resets automatically after all errors (M1, M2 and M3 are set low), see the data sheet for further explanation. This mean that the device will restart itself after an error occasion and reports through the \overline{SD} error signal.

3.2 Fault Reporting

The \overline{OTW} and \overline{SD} outputs from TAS5162 indicate fault conditions. See the TAS5162 data manual for a description of these pins.

Table 3. TAS5162 Warning/Error Signal Decoding

\overline{OTW}	\overline{SD}	Device Condition
0	0	High temperature error and/or high current error
0	1	High temperature warning
1	0	Undervoltage lockout or high current error
1	1	Normal operation, no errors/warnings

The temperature warning signals at the TAS5162DKD6EVM board are wired — or to one temperature warning signal (\overline{OTW} - pin 22 in control interface connector). Shutdown signals are wired-or into one shutdown signal (\overline{SD} - pin 20 in control interface connector).

The shutdown signals together with the temperature warning signal give chip state information as described in [Table 3](#). Device fault reporting outputs are open-drain outputs.

4 TAS5162DKD6EVM Performance

All electrical and audio specifications are typical values.

Table 4. General Test Conditions

General Test Conditions ⁽¹⁾		Notes
Output Stage Supply Voltage:	50 V	Laboratory Power Supply (EA-PS 7065-10A)
System Supply Voltage:	15 V	
Load Impedance BTL:	6-8 Ω	
Load Impedance PBTL:	3-4 Ω	
Input Signal	1 kHz Sine	
Sampling Frequency	48 kHz	
Gain setting in TAS5518	0 dB	
Measurement Filter	AES17 and AUX0025	
TI Input-USB Board	Input-USB	Rev 10
EVM configuration file	Ver 1.00	TAS5162DKD6EVM Configuration (1.00).cfg

⁽¹⁾ These test conditions are used for all tests, unless otherwise specified.

Table 5. TAS5518 Register Settings

Register ⁽¹⁾		Value	Notes
Modulation Index Limit Register	0x16	0x04	Set Modulation Index to 96.1%
Master Volume Register	0xD9	00 00 00 48	Master Volume set to 0 dB

⁽¹⁾ These register settings are used for all test, unless otherwise specified.

Table 6. Electrical Data

Electrical Data		Notes/Conditions
Output Power, BTL, 6 Ω:	155 W	1 kHz, unclipped (0 dBFS), T _A = 25°C
Output Power, BTL, 6 Ω:	210 W	1 kHz, 10% THD+N, T _A = 25°C
Output Power, BTL, 8 Ω:	125 W	1 kHz, unclipped (0 dBFS), T _A = 25°C
Output Power, BTL, 8 Ω:	160 W	1 kHz, 10% THD+N, T _A = 25°C
Output Power, PBTL, 4 Ω:	240 W	1 kHz, unclipped (0 dBFS), T _A = 25°C
Output Power, PBTL, 4 Ω:	315 W	1 kHz, 10% THD+N, T _A = 25°C
Maximum Peak Current, BTL:	>10 A	1 kHz burst, 1 Ω, R _{OC} = 22 k
Maximum Peak Current, PBTL:	>20 A	1 kHz burst, 1 Ω, R _{OC} = 22 k
Output Stage Efficiency:	90%	2 x channels, 8 Ω
Damping Factor BTL:	15	1 kHz, relative to 8 Ω load
Damping Factor PBTL:	15	1 kHz, relative to 4 Ω load
System Supply Current:	<270 mA	1 kHz, -60 dBFS signal, with TI input board
H-Bridge Supply Current:	<187 mA	1 kHz, -60 dBFS signal
Total Board Idle Power Consumption:	13.4 W	H-Bridge supply + System supply, -60 dBFS signal

Table 7. Audio Performance

Audio Performance			Notes/Conditions
THD+N, BTL, 6 Ω:	1 W	<0.02%	1 kHz
THD+N, BTL, 6 Ω:	10 W	<0.05%	1 kHz
THD+N, BTL, 6 Ω:	50 W	<0.08%	1 kHz
THD+N, BTL, 6 Ω:	100 W	<0.10%	1 kHz
THD+N, BTL, 6 Ω:	150 W	<0.13%	1 kHz
THD+N, BTL, 8 Ω:	1 W	<0.02%	1 kHz
THD+N, BTL, 8 Ω:	10 W	<0.07%	1 kHz
THD+N, BTL, 8 Ω:	50 W	<0.06%	1 kHz
THD+N, BTL, 8 Ω:	100 W	<0.07%	1 kHz
THD+N, PBTL, 4 Ω:	1 W	<0.009%	1 kHz
THD+N, PBTL, 4 Ω:	10 W	<0.05%	1 kHz
THD+N, PBTL, 4 Ω:	50 W	<0.04%	1 kHz
THD+N, PBTL, 4 Ω:	100 W	<0.04%	1 kHz
THD+N, PBTL, 4 Ω:	200 W	<0.12%	1 kHz
Dynamic Range:		>109 dB	Ref: rated power, A-weighted, AES17 filter, 4 ch avg
Noise Voltage:		<110 μVrms	A-weighted, AES17 filter
Click/Pop, DC step BTL:		10 mV	Mute/Unmute, No signal, 6 Ω
Click/Pop, DC step PBTL:		23 mV	Mute/Unmute, No signal, 4 Ω
Channel Separation:		>65 dB	1 kHz
Frequency Response:		+0.8 / 0.0 dB	125 W / 8 Ω, unclipped (0 dBFS)

Table 8. Audio Performance Subwoofer Line Output

Audio Performance			Notes/Conditions
Full Scale Output Voltage Swing, 0 dBFS:		1.275 Vrms	1 kHz, 10 kΩ load
Full Scale Output Voltage Swing, 10 % THD+N:		1.5 Vrms	1 kHz, 10 kΩ load
THD+N, 10 kΩ:	1 V	<0.014%	1 kHz
THD+N, 10 kΩ:	100 mV	<0.02%	1 kHz
Frequency Response:		+1, -6 dB	20 Hz - 20 kHz
Dynamic Range:		>96 dB	20 Hz - 20 kHz
Noise Voltage:		<20 μV	20 Hz - 20 kHz

Table 9. Thermal Specifications

Thermal Specifications	T _{HEATSINK} ⁽¹⁾	Notes/Conditions
Idle, All Channels Switching	41°C	1 kHz, 15 min, -60 dBFS signal, T _A = 25°C 1 kHz
6 x 16 W, 8 Ω + 1 x 32 W, 4 Ω (1/8 power)	63°C	1 kHz, 1 hour, T _A = 25°C
2 x 125 W, 8 Ω	73°C	1 kHz, 5 min, T _A = 25°C

⁽¹⁾ Measured on surface of heatsink.

Table 10. Physical Specifications

Physical Specification		Notes/Conditions
PCB Dimensions:	160 x 172 x 55	Width x Length x Height (mm)
Total Weight:	640 gr.	Components + PCB + Heat-sink + Mechanics

4.1 THD+N vs Power (BTL - 6Ω)

Gain: 2.5 dB set in TAS5518

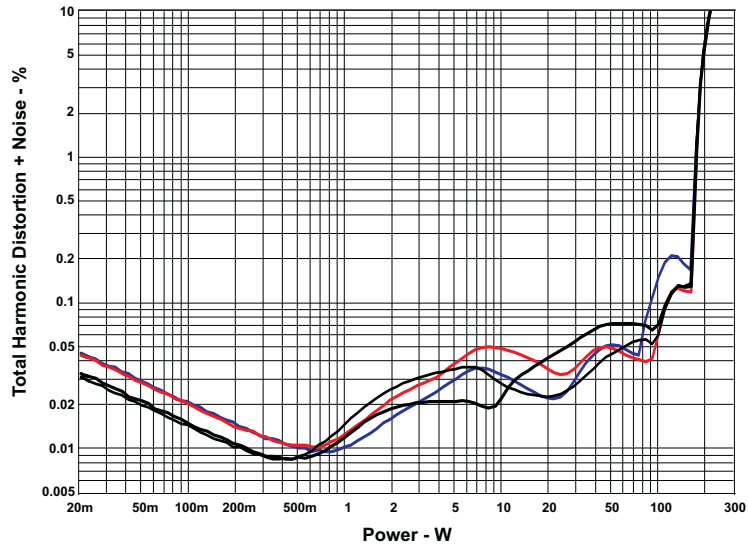


Figure 4. THD+N vs Power (BTL - 6Ω)

4.2 THD+N vs Power (BTL - 8Ω)

Gain: 2.5 dB set in TAS5518

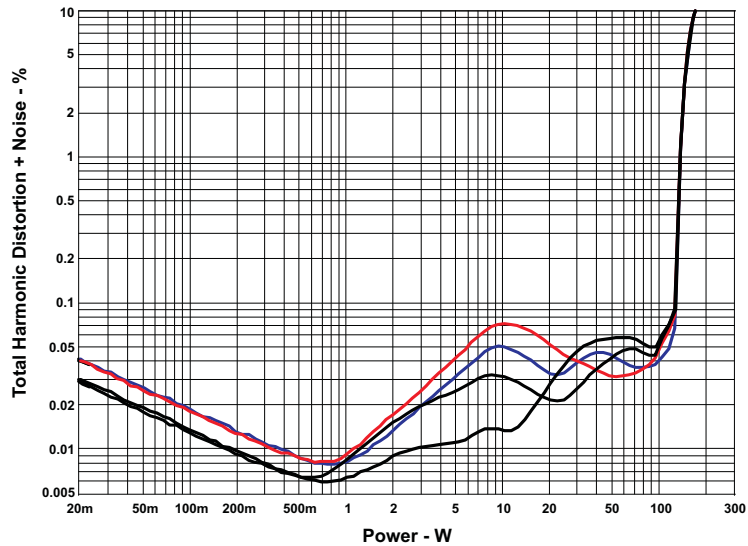


Figure 5. THD+N vs Power (BTL - 8Ω)

4.3 THD+N vs Power (PBTL - 4Ω)

Gain: 2.5 dB set in TAS5518

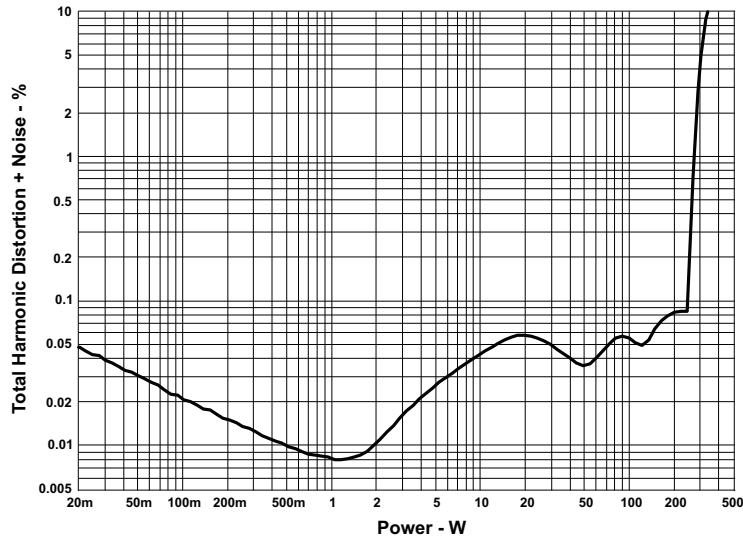


Figure 6. THD+N vs Power (PBTL - 4Ω)

4.4 THD+N vs Frequency (BTL - 6Ω)

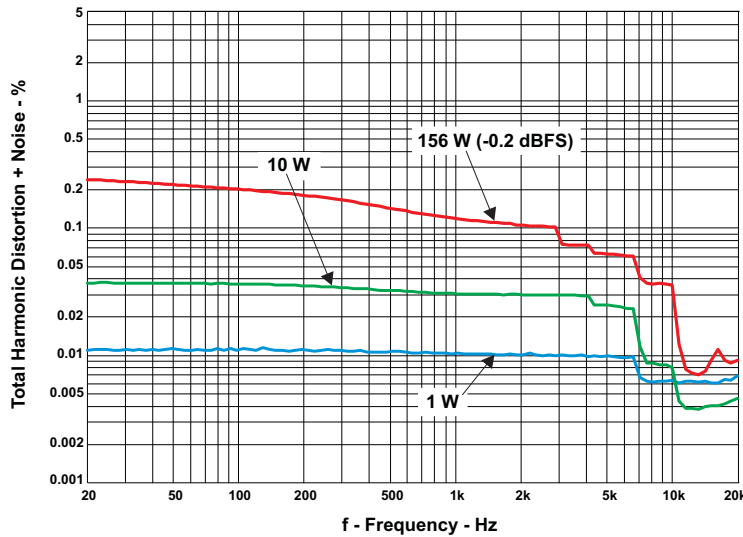


Figure 7. THD+N vs Frequency (BTL - 6Ω)

4.5 THD+N vs Frequency (BTL - 8Ω)

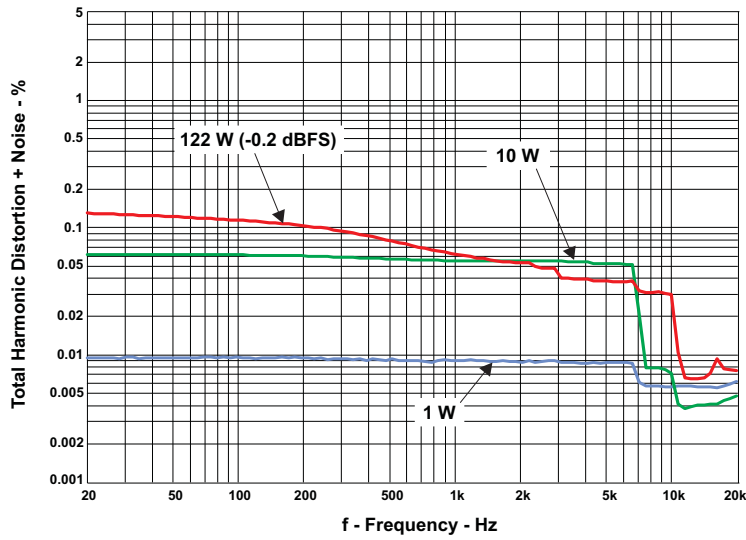


Figure 8. THD+N vs Frequency (BTL - 8Ω)

4.6 THD+N vs Frequency (PBTL - 4Ω)

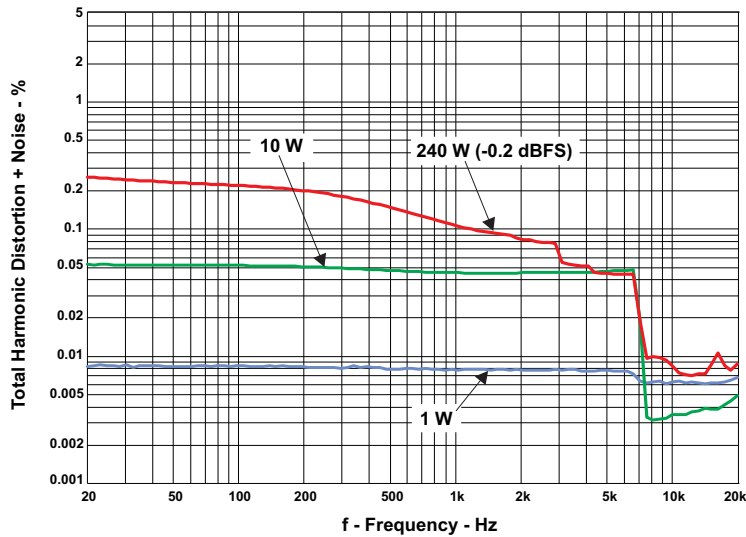


Figure 9. THD+N vs Frequency (PBTL - 4Ω)

4.7 FFT Spectrum With -60 dBFS Tone (BTL)

Reference voltage is 31.3 V. FFT size 16 k.

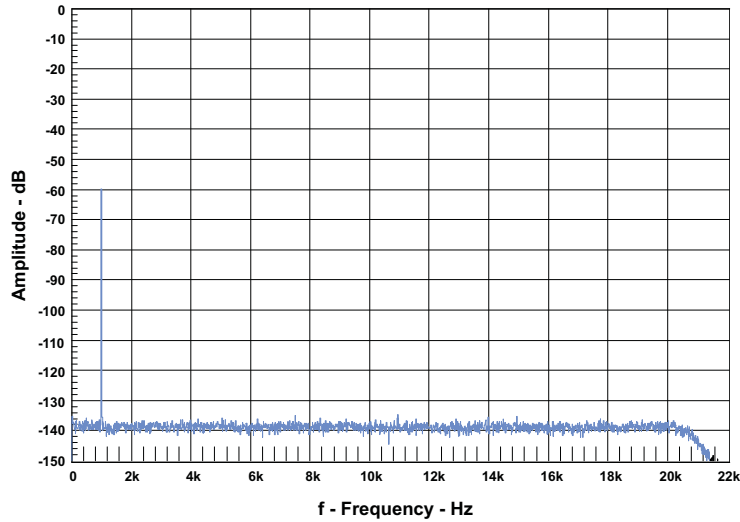


Figure 10. FFT Spectrum With -60 dBFS Tone (BTL)

4.8 FFT Spectrum With -60 dBFS Tone (PBTL)

Reference voltage is 31.7 V. FFT size 16 k.

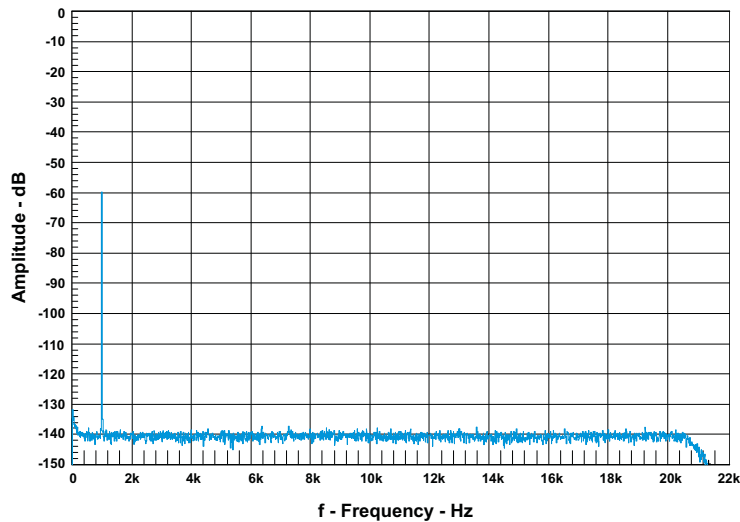


Figure 11. FFT Spectrum With -60 dBFS Tone (PBTL)

4.9 Idle Noise FFT Spectrum (BTL)

Automute disabled — Register x04h set to x60h. Reference voltage is 31.3 V. FFT size 16 k.

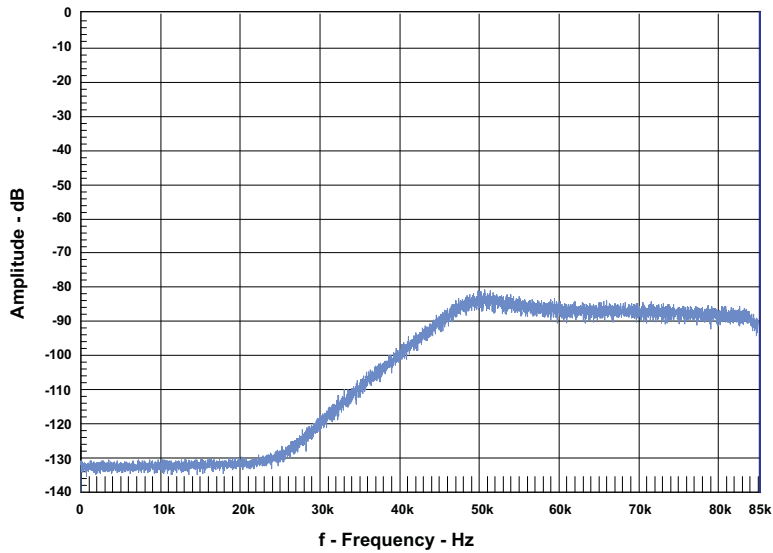


Figure 12. Idle Noise FFT Spectrum (BTL)

4.10 Idle Noise FFT Spectrum (PBTL)

Automute disabled — Register x04h set to x60h. Reference voltage is 31.7 V. FFT size 16 k.

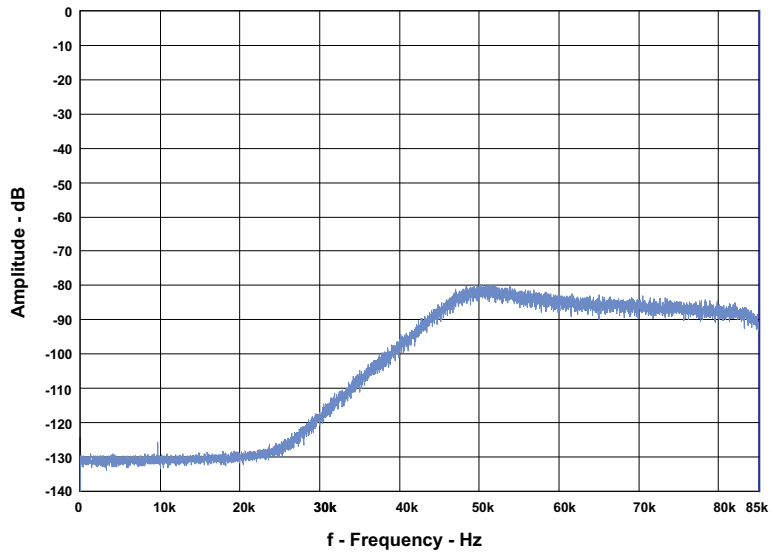


Figure 13. Idle Noise FFT Spectrum (PBTL)

4.11 Channel Separation

Channel separation is tested for two channels in different package, channel 1 and channel 2. 8 Ω loads are used for both channels. Channel 1 input signal is 0 dBFS, channel 2 muted. Reference voltage is 31.9 Vrms

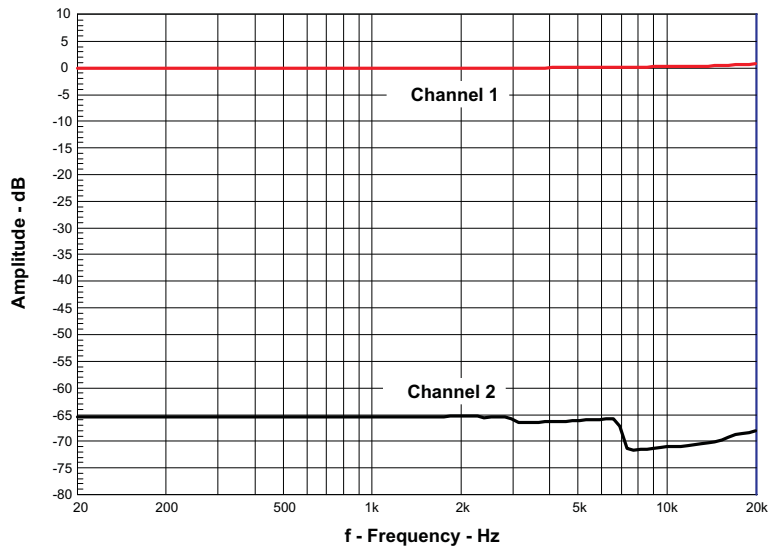


Figure 14. Channel Separation

4.12 Frequency Response (BTL)

Measurement bandwidth filter 80 kHz.

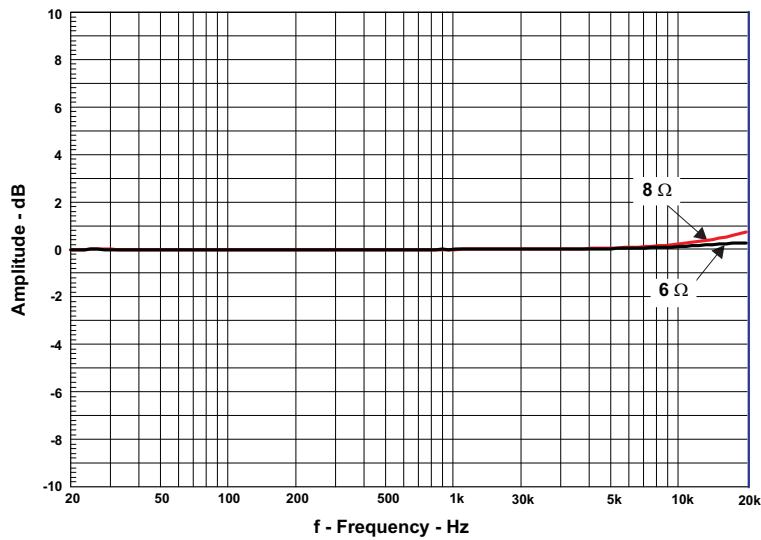


Figure 15. Frequency Response (BTL)

4.13 Frequency Response (PBTL)

Measurement bandwidth filter 80 kHz.

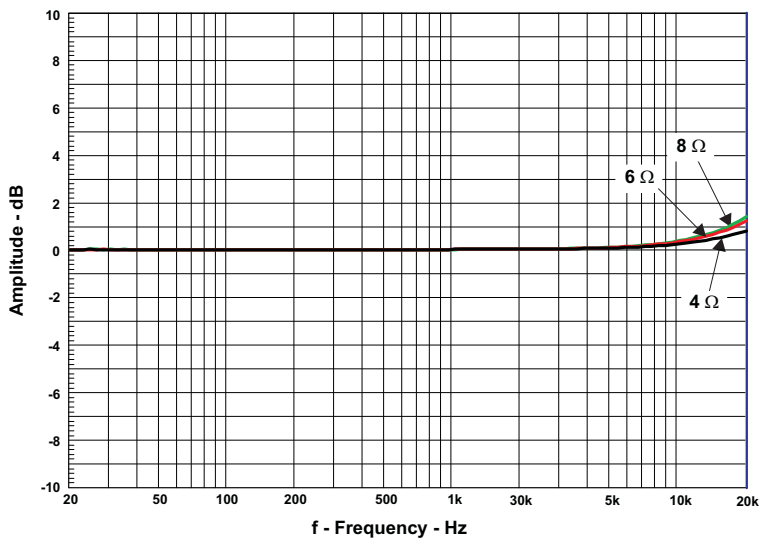


Figure 16. Frequency Response (PBTL)

4.14 High Current Protection (BTL)

Input 1 kHz bursted signal, Load 1 Ω.

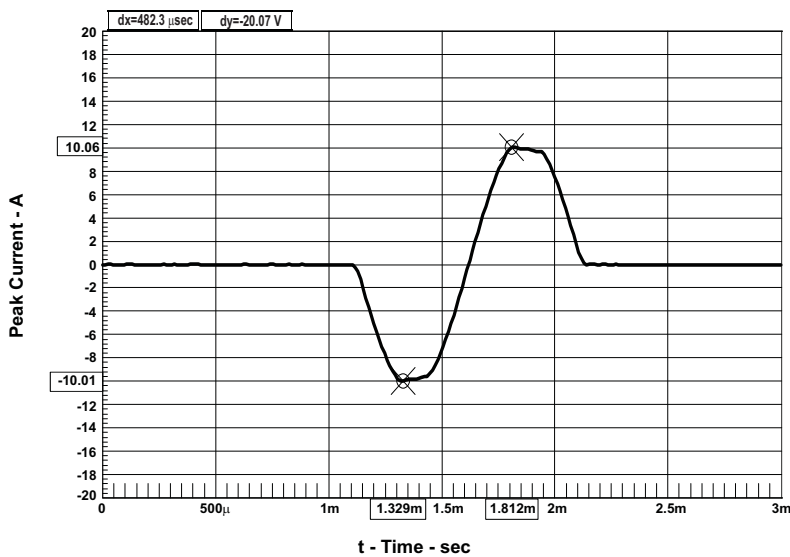


Figure 17. High Current Protection (BTL)

4.15 High Current Protection (PBTL)

Input 1 kHz bursted signal, Load 1 Ω .

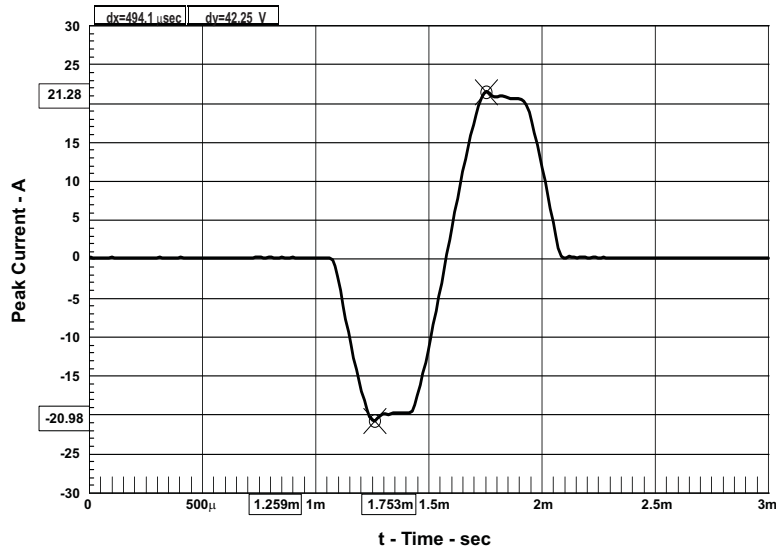


Figure 18. High Current Protection (PBTL)

4.16 Pop/Click (BTL)

No input signal applied. The measurement results are presented both in time domain and in frequency domain.

Test with automute disabled — Register x04h set to x60h. No input signal applied. Load 6 Ω .

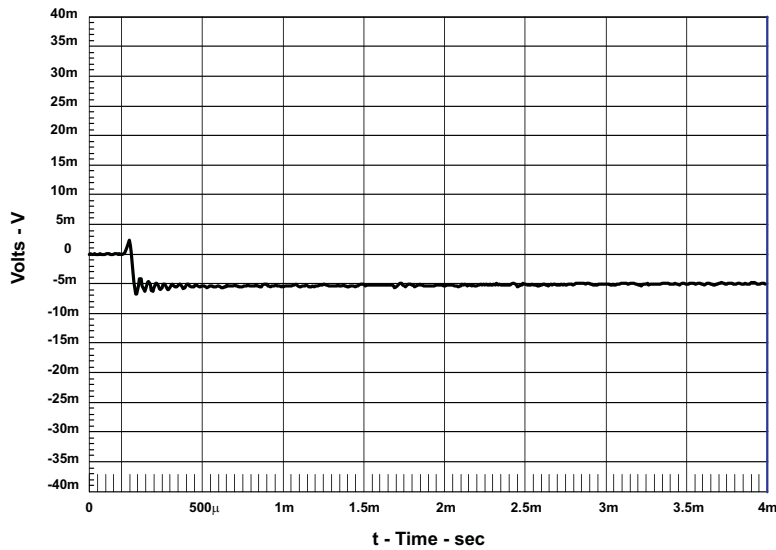


Figure 19. Pop/Click (BTL)

4.17 Pop/Click (PBTL)

No input signal applied. The measurement results are presented both in time domain and in frequency domain.

Test with automute disabled — Register x04h set to x60h. No input signal applied. Load 4 Ω .

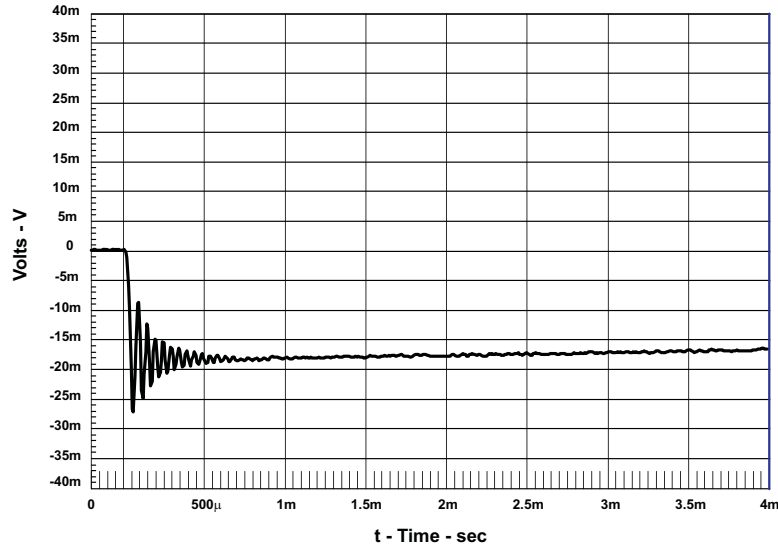


Figure 20. Pop/Click (PBTL)

4.18 Output Stage Efficiency

Efficiency is tested with 2 channels loaded 8 Ω . The board has been preheated for 1 hour at 1/8 output power.

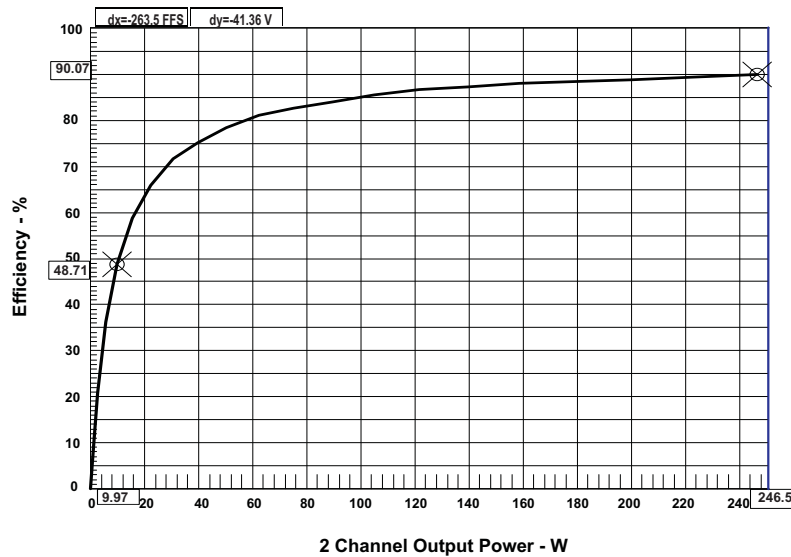


Figure 21. Output Stage Efficiency

4.19 Subwoofer Line Out THD Vs. Output Voltage

Gain: 2.5 dB set in TAS5518

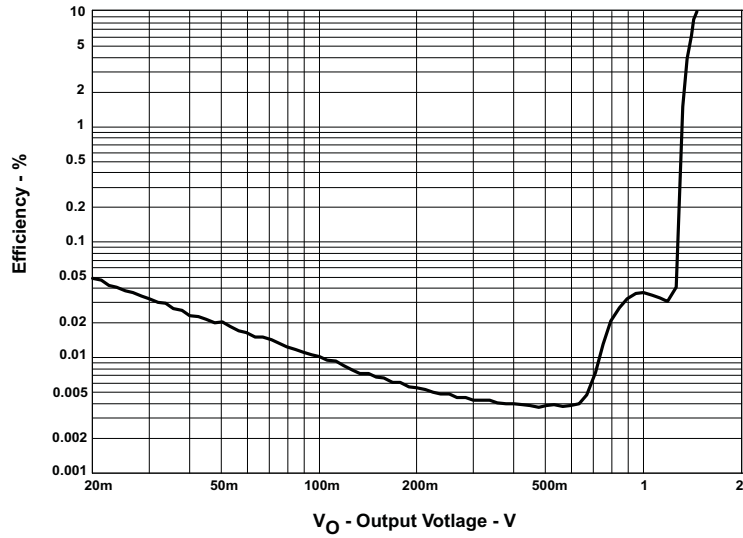


Figure 22. Subwoofer Line Out THD Vs. Output Voltage

4.20 Subwoofer Line Out THD+N vs. Frequency

Load 10 k Ω .

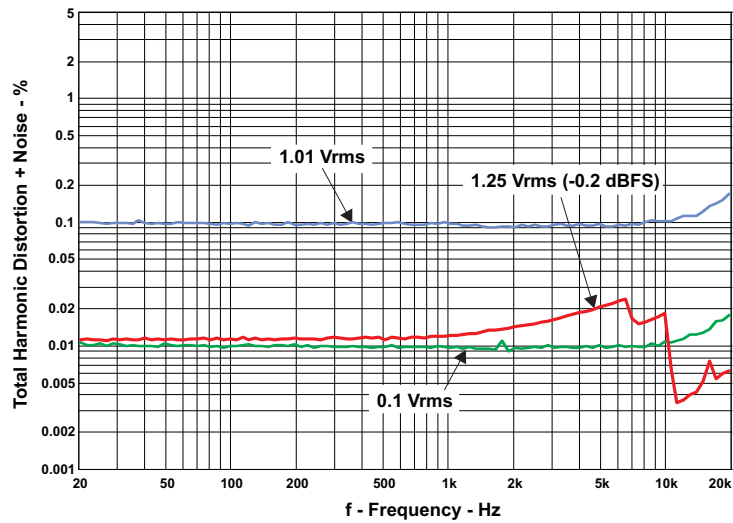


Figure 23. Subwoofer Line Out THD+N vs. Frequency

4.21 Subwoofer Line Out Frequency Response

Measurement bandwidth filter 80 kHz. Load 10 kΩ.

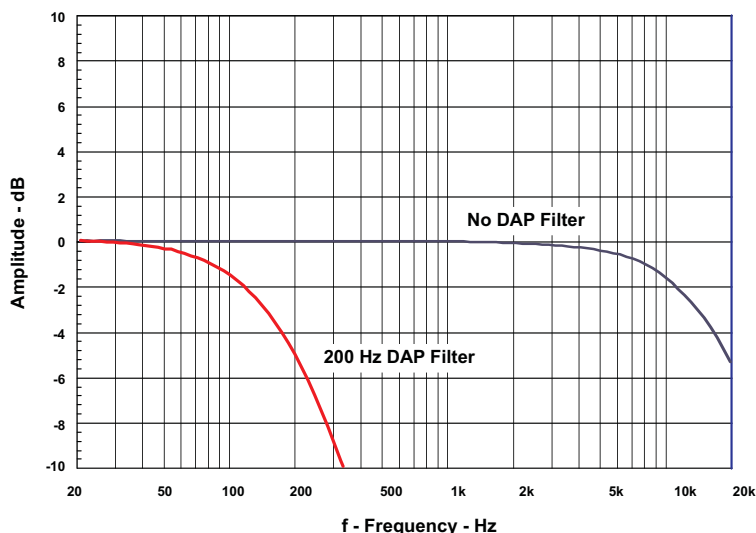


Figure 24. Subwoofer Line Out Frequency Response

5 Related Documentation from Texas Instruments

Table 11 contains a list of data manuals that have detailed descriptions of the integrated circuits used in the design of the TAS5162DKD6EVM. The data manuals can be obtained at the <http://www.ti.com>.

Table 11. Related Documentation from Texas Instruments

Part Number	Literature Number
TAS5518	SLES115
TAS5162	SLES194
TLV272	SLOS351
TPS3825-33	SLVS165
TPS5430	SLVS632
TPS76733	SLVS208
TPS79133	SLVS325

5.1 Additional Documentation

1. PC Configuration Tool for TAS5518 (TAS5518 GUI ver. 4.0 or later)
2. System Design Considerations for True Digital Audio Power Amplifiers ([SLAA117](#))
3. Digital Audio Measurements ([SLAA114](#))
4. PSRR for PurePath Digital Audio Amplifiers ([SLEA049](#))
5. Power Rating in Audio Amplifier ([SLEA047](#))
6. PurePath Digital AM Interference Avoidance ([SLEA040](#))
7. Click & Pop Measurements Technique ([SLEA044](#))
8. Power Supply Recommendations for DVD-Receivers ([SLEA027](#))
9. Implementation of Power Supply Volume Control ([SLEA038](#))

Appendix A

A.1 Design Documents

Table A-1. Design Documents

Appendix	Document	Version	Pages
A.1	TAS5162DKD6EVM Schematic	Version 2.00	8 pages
A.2	TAS5162DKD6EVM Parts List	Version 2.00	2 pages
A.3	TAS5162DKD6EVM PCB Specification	Version 1.00	1 pages
A.4	TAS5162DKD6EVM PCB Layers	Version 1.00	4 pages
A.5	Heat Sink Drawing	Version 1.00	1 pages



Board Name: **TAS5162DKD6EVM**
 Type: Mass Market Evaluation Module
 File Name: A830-SCH-001.DSN
 Version: 2.00
 Date: 15.June 2007
 Engineer: Jonas L. Holm

Audio Configuration: 3-6 Channel PurePath Digital Amplifier Design with Subwoofer line out
 1 x TAS5518PAG, 3 x TAS5162DKD
 1 x Subwoofer Line Out (TLV272)

Interfaces: J30: 34 pin IDC Header for Control, I2C and +5V
 J60: 16 pin IDC Header for I2S Audio
 J101-J108: 2 pin 3.96mm Headers for Speakers
 J600: RCA Connector for Subwoofer Line Out
 J900: 4 pin 3.96mm Header for H-Bridge Power Supply (Optional)
 J901: 4 pin 3.96mm Header for H-Bridge and System Power Supply
 J902: 5 pin 2.54mm Header for PSU Control

Setup: 8 Ohm (BTL) and 4 Ohm (PBTL) Speaker Loads
 +50V H-Bridge and +15V System Power Supplies

Performance: 125 W / 8 Ohm (BTL) unclipped, or 210 W / 6 Ohm (BTL) 10% THD+N
 110 dB Dynamic Range

Page

- 1/8: Front Page and Schematic Disclaimer
- 2/8: Overview - Modulator, Input/Output and Headphone Connectors
- 3/8: Power Stage 1
- 4/8: Power Stage 2
- 5/8: Power Stage 3
- 6/8: Subwoofer Line Out
- 7/8: Power Supplies
- 8/8: Mechanics

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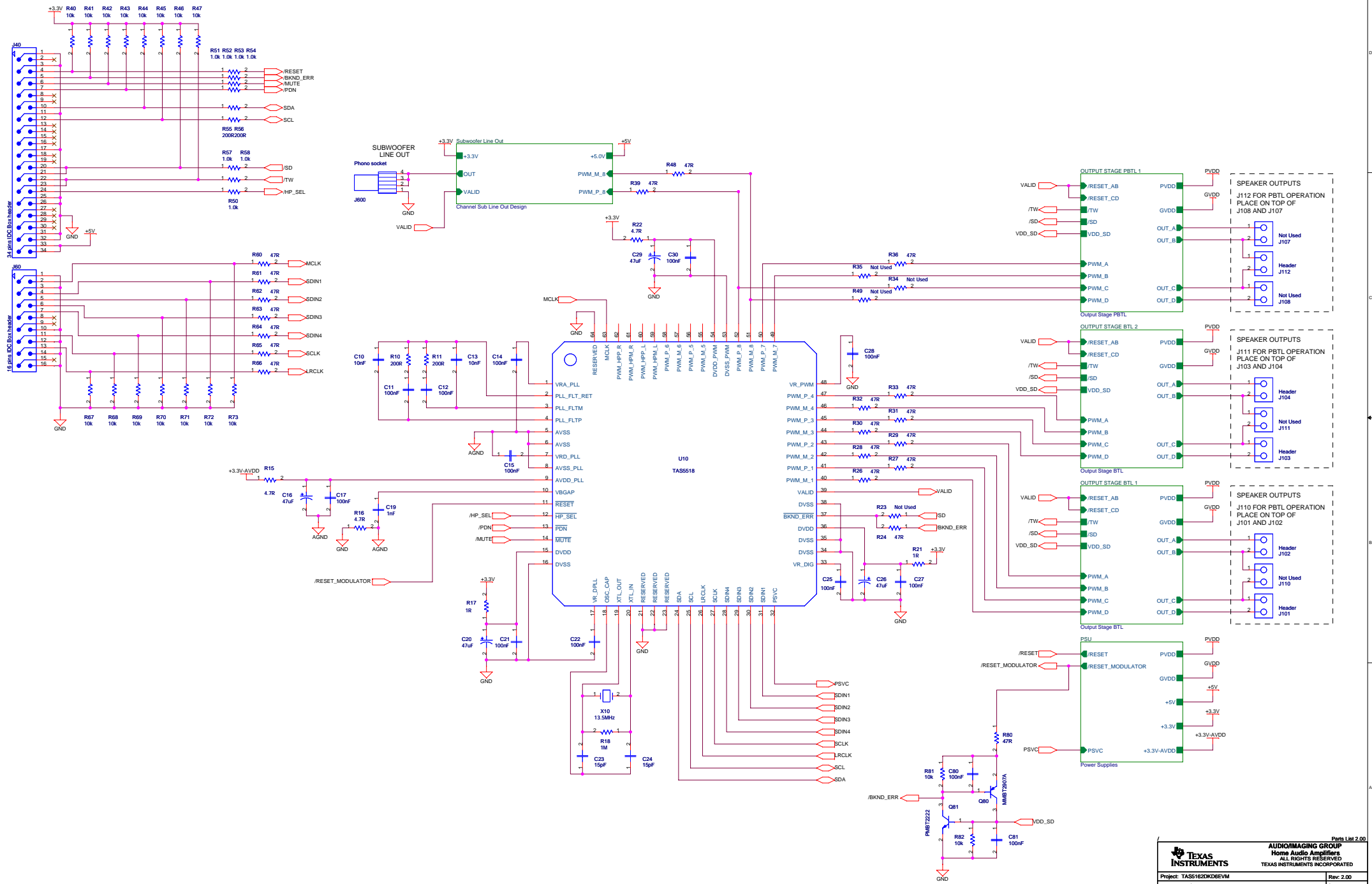
NOTE1

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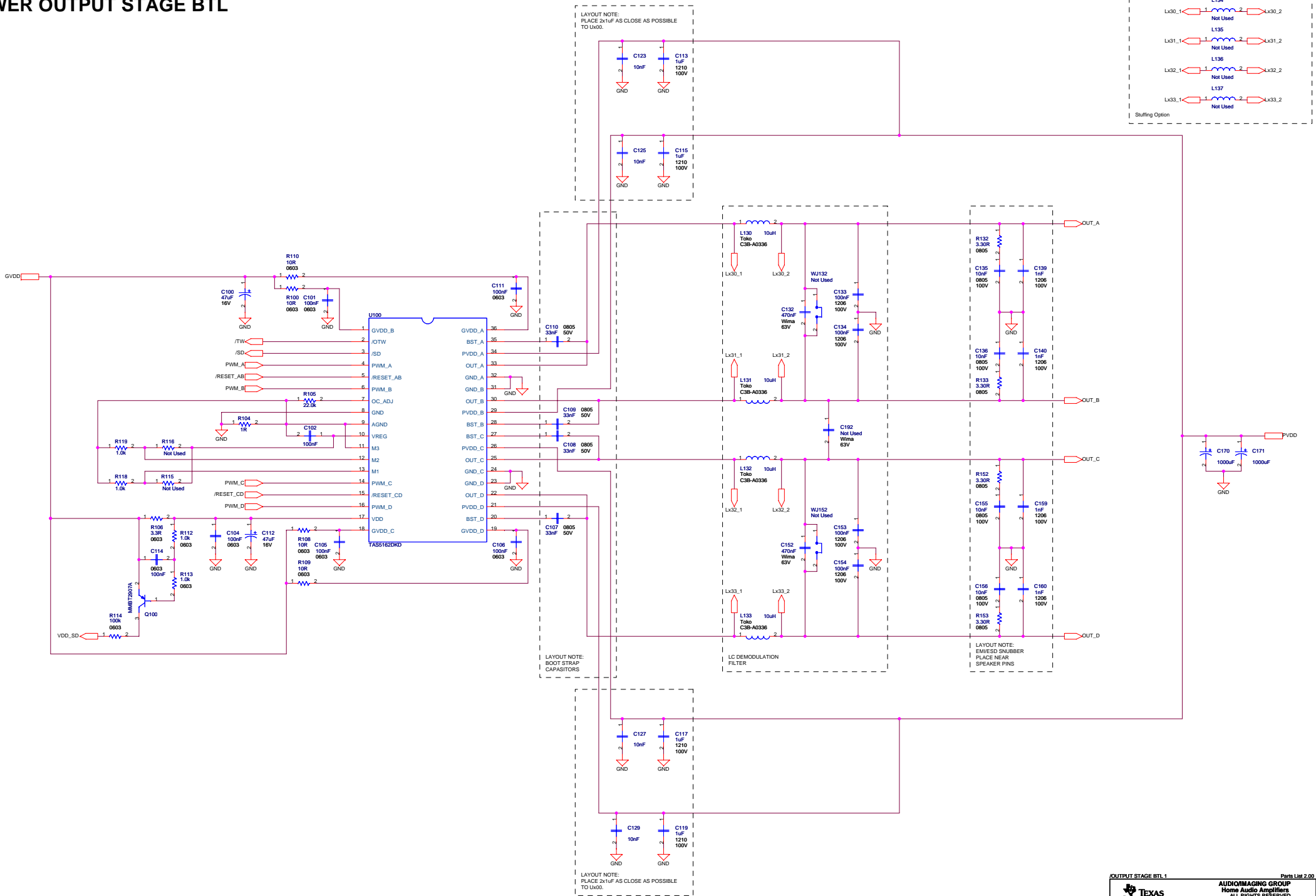
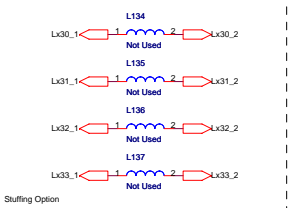
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Not Used



POWER OUTPUT STAGE BTL

LAYOUT NOTE:
PLACE 2x1uF AS CLOSE AS POSSIBLE
TO Ux00.



LAYOUT NOTE:
BOOT STRAP
CAPACITORS

LAYOUT NOTE:
LC DEMODULATION
FILTER

LAYOUT NOTE:
EMWISSD SNIFFER
PLACE NEAR
SPEAKER PINS

LAYOUT NOTE:
PLACE 2x1uF AS CLOSE AS POSSIBLE
TO Ux00.

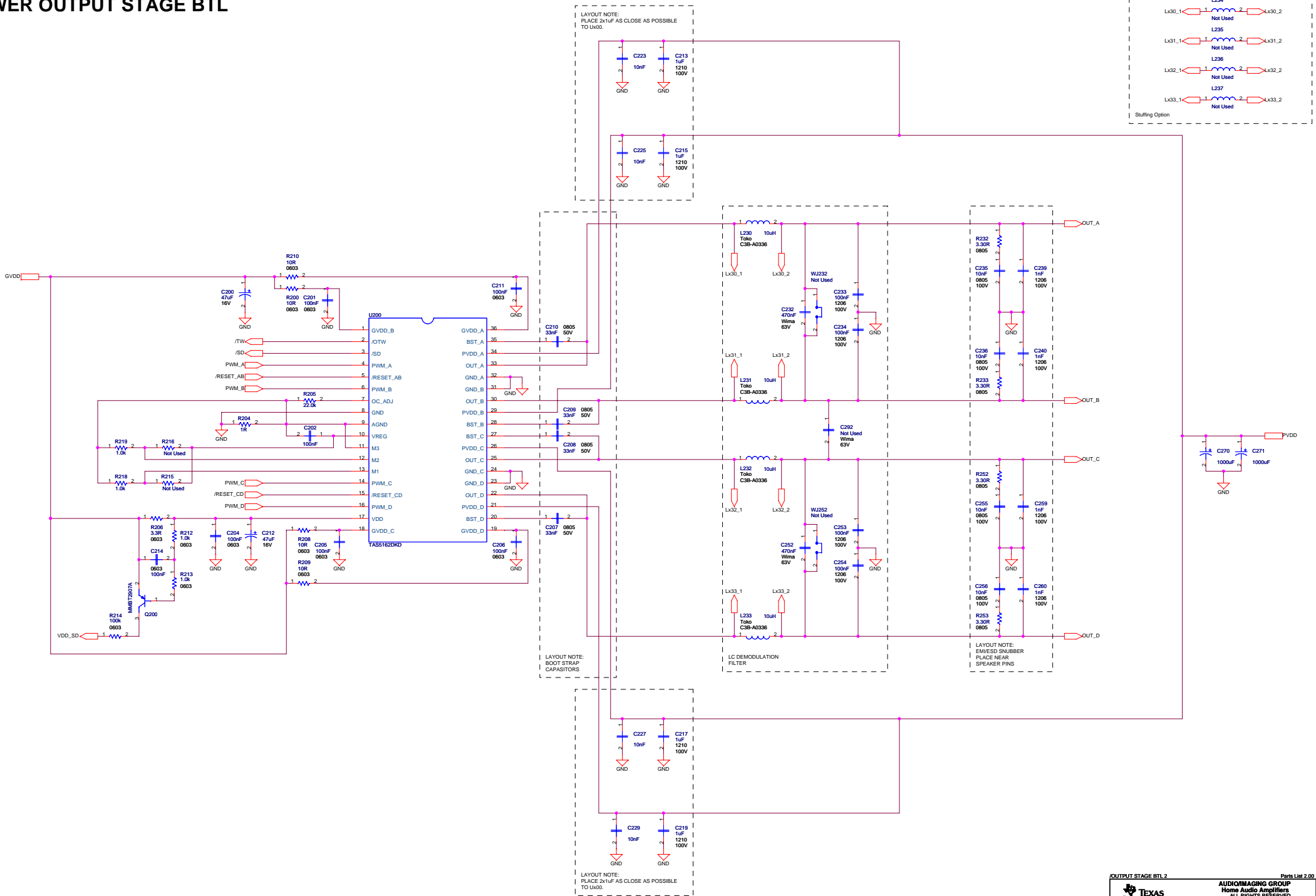
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File Name: A230-SC04-001.DSN	Engineer: Jonas L. Holm	
Date: Friday, May 26, 2007		Page: 3 of 8

OUTPUT STAGE BTL 1
TEXAS INSTRUMENTS
 AUDIO/IMAGING GROUP
 Home Audio Amplifiers
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POWER OUTPUT STAGE BTL

LAYOUT NOTE:
PLACE 2x1uF AS CLOSE AS POSSIBLE
TO Ux00.

- Lx30_1 1 2 Lx30_2
 - L234 Not Used
 - Lx31_1 1 2 Lx31_2
 - L235 Not Used
 - Lx32_1 1 2 Lx32_2
 - L236 Not Used
 - Lx33_1 1 2 Lx33_2
 - L237 Not Used
- Stuffing Option



LAYOUT NOTE:
BOOT STRAP
CAPACITORS

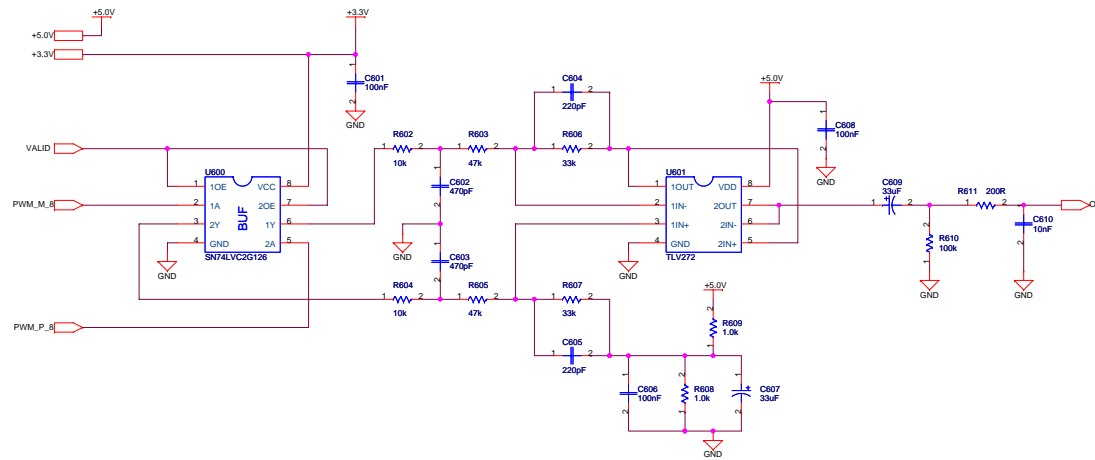
LC DEMODULATION
FILTER

LAYOUT NOTE:
EMBEDDED SNIFFER
PLACE NEAR
SPEAKER PINS

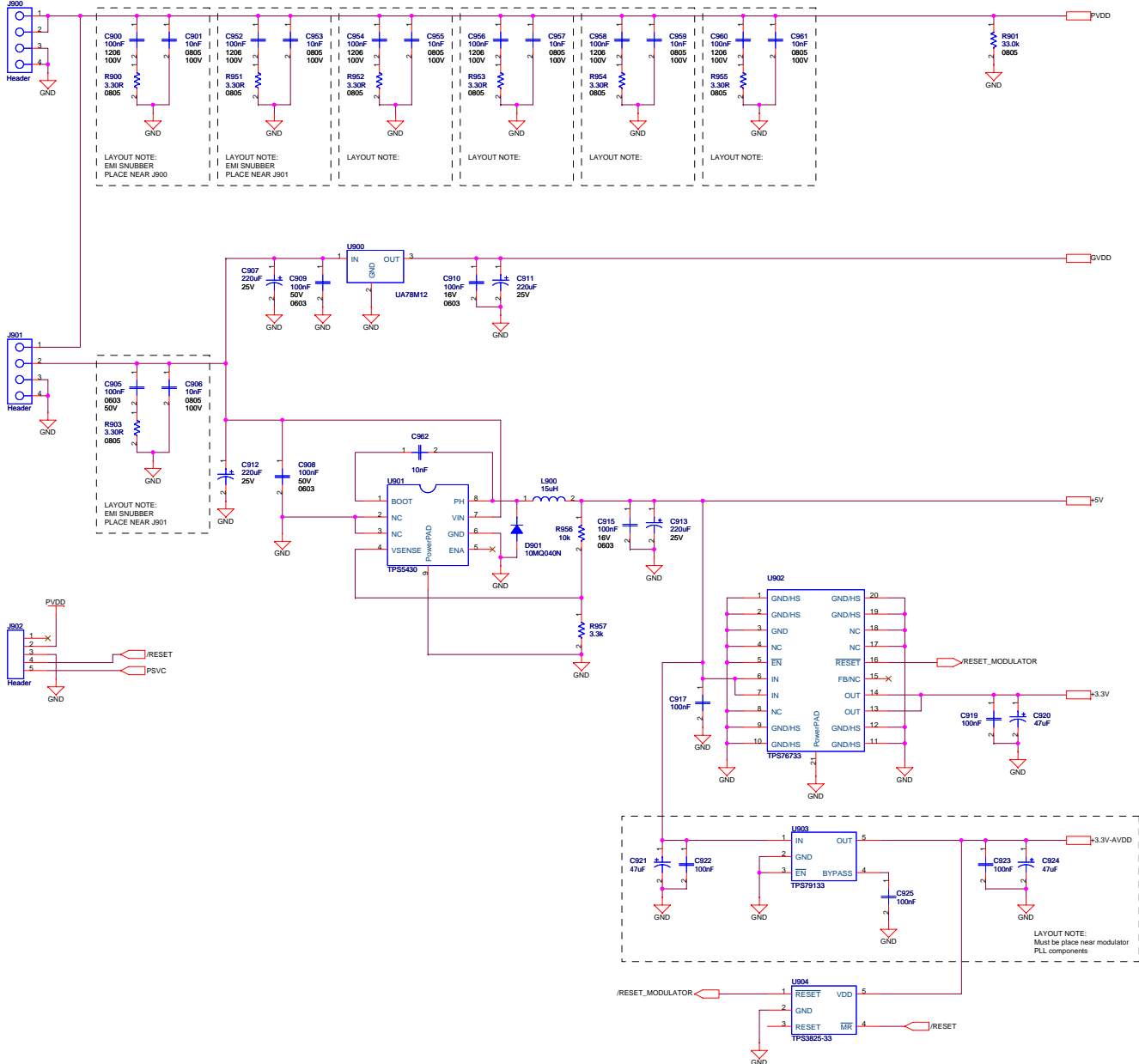
LAYOUT NOTE:
PLACE 2x1uF AS CLOSE AS POSSIBLE
TO Ux00.

OUTPUT STAGE BTL 2		Parts List 2.00	
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Date: Friday, May 26, 2007	Engineer: Jonas L. Holm	Page 4 of 8	

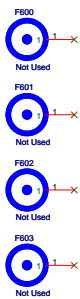
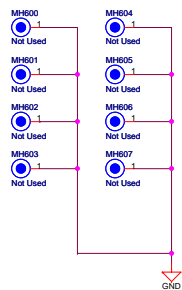
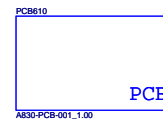
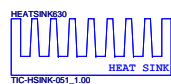
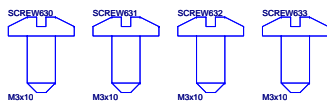
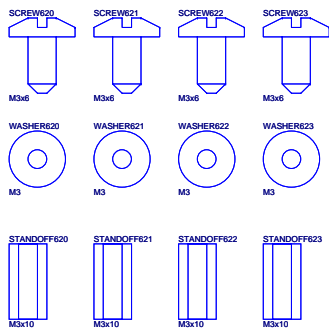
SUBWOOFER LINE OUT



POWER SUPPLIES



MECHANICS



TAS5162DKD6EVM Partslist (2.00)



Qty	Part Reference	Description	Manufacture	First Mfr P/N
1	R901	33.0k / 125mW / 1% / 0805 Thick Film Resistor	Yageo	RC0805FR-0733KL
19	R132 R133 R152 R153 R232 R233 R252 R253 R332 R333 R352 R353 R900 R903 R951 R952 R953 R954 R955	3.30R / 125mW / 1% / 0805 Thick Film Resistor	Yageo	RC0805FR-073R3L
21	R50 R51 R52 R53 R54 R57 R58 R112 R113 R118 R119 R212 R213 R218 R219 R312 R313 R315 R316 R608 R609	1.0k / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-071KL
20	R40 R41 R42 R43 R44 R45 R46 R47 R67 R68 R69 R70 R71 R72 R73 R81 R82 R602 R604 R956	10k / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-0710KL
4	R114 R214 R314 R610	100k / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-07100KL
1	R18	1M / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-071ML
5	R17 R21 R104 R204 R304	1R / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-071RL
12	R100 R108 R109 R110 R200 R208 R209 R210 R300 R308 R309 R310	10R / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-0710RL
5	R10 R11 R55 R56 R611	200R / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-07200RL
3	R105 R205 R305	22.0k / 100mW / 1% / 0603 Thick Film Resistor	Yageo	RC0603FR-0722KL
1	R957	3.3k / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-073K3L
2	R606 R607	33k / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-0733KL
3	R106 R206 R306	3.3R / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-073R3L
2	R603 R605	47k / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-0747KL
3	R15 R16 R22	4.7R / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-074R7L
20	R24 R26 R27 R28 R29 R30 R31 R32 R33 R36 R39 R48 R60 R61 R62 R63 R64 R65 R66 R80	47R / 100mW / 5% / 0603 Thick Film Resistor	Yageo	RC0603JR-0747RL
31	C123 C125 C127 C129 C135 C136 C155 C156 C223 C225 C227 C229 C235 C236 C255 C256 C323 C325 C327 C329 C335 C336 C355 C356 C901 C906 C953 C955 C957 C959 C961	Ceramic 10nF / 100V / 20% X7R 0805 Capacitor	BC Components	0805B103M101NT
12	C107 C108 C109 C110 C207 C208 C209 C210 C307 C308 C309 C310	Ceramic 33nF / 50V / 20% X7R 0805 Capacitor	BC Components	0805B333M500NT
12	C139 C140 C159 C160 C239 C240 C259 C260 C339 C340 C359 C360	Ceramic 1nF / 100V / 10% NP0 1206 Capacitor	BC Components	1206N102K101NT
16	C133 C134 C153 C154 C233 C234 C253 C254 C334 C353 C900 C952 C954 C956 C958 C960	Ceramic 100nF / 100V / 20% X7R 1206 Capacitor	BC Components	1206B104M101NT
12	C113 C115 C117 C119 C213 C215 C217 C219 C313 C315 C317 C319	Ceramic 1uF / 100V / 10% X7R 1210 Capacitor	Murata	GRM32ER72A105KA01L
4	C10 C13 C610 C962	Ceramic 10nF / 50V / 20% X7R 0603 Capacitor	Vishay	VJ0603Y103MXA
44	C11 C12 C14 C15 C17 C21 C22 C25 C27 C28 C30 C80 C81 C101 C102 C104 C105 C106 C111 C114 C201 C202 C204 C205 C206 C211 C214 C301 C302 C304 C305 C306 C311 C314 C601 C606 C608 C910 C915 C917 C919 C922 C923 C925	Ceramic 100nF / 16V / 20% X7R 0603 Capacitor	Vishay	VJ0603Y104MXJ
3	C905 C908 C909	Ceramic 100nF / 50V / 20% X7R 0603 Capacitor	Vishay	VJ0603Y104MXA
1	C19	Ceramic 1nF / 50V / 10% NP0 0603 Capacitor	BC Components	0603N102K500NT
2	C23 C24	Ceramic 15pF / 50V / 10% NP0 0603 Capacitor	BC Components	0603N150K500NT
2	C604 C605	Ceramic 220pF / 50V / 10% NP0 0603 Capacitor	BC Components	0603N221K500NT
2	C602 C603	Ceramic 470pF / 50V / 10% NP0 0603 Capacitor	BC Components	0603N471K500NT
6	C170 C171 C270 C271 C370 C371	Electrolytic 1000uF / 63V / 20% Aluminium 7.5mm ø16mm FC Series - Low Impedance Capacitor	Panasonic	EEUF1J102
4	C907 C911 C912 C913	Electrolytic 220uF / 25V / 20% Aluminium 3.5mm ø8mm FC Series - Low Impedance Capacitor	Panasonic	EEUF1E221
2	C607 C609	Electrolytic 33uF / 16V / 20% Aluminium 2mm ø5mm Low ESR (0.26R) Capacitor	Rubycon	16ZA33M5X7
13	C16 C20 C26 C29 C100 C112 C200 C212 C300 C312 C920 C921 C924	Electrolytic 47uF / 16V / 20% Aluminium 2mm ø5mm FC Series - Low Impedance Capacitor	Panasonic	EEUF1C470
1	C392	Metal Film 1uF / 63V / 10% Polyester 7.5mm (W:6mm L:10mm) Capacitor	Wima	MKS 4 1uF/10%/63Vdc PCM7.5
4	C132 C152 C232 C252	Metal Film 470nF / 63V / 10% Polyester 7.5mm (W:4.5mm L:10mm) Capacitor	Wima	MKS 4 0.47uF/10%/63Vdc PCM7.5
12	L130 L131 L132 L133 L230 L231 L232 L233 L330 L331 L332 L333	10uH / Ferrite Inductor	Toko	C3B-A0336
1	L900	15uH / Ferrite Inductor	Kwang Sung	8020P-06-150L
2	WJ332 WJ352	Wire Jumper / Wire ø0.9mm (SWG20), Pitch 7.5mm, Copper Tinned Wire Jumper Inductor	n/a	n/a
1	D901	1A / 40V Schottky 10MQ040N Diode (SMA)	Int. Rectifier	10MQ040N
1	Q81	600mA / 40V NPN Small signal PMBT2222 Transistor (SOT-23)	Philips	PMBT2222
4	Q80 Q100 Q200 Q300	800mA / 40V PNP Small signal MMBT2907A Transistor (SOT-23)	Fairchild	MMBT2907A
3	U100 U200 U300	TAS5162DKD / Stereo Digital Audio PWM Power Output Stage (PSOP3-36)	Texas Instruments	TAS5162DKD
1	U10	TAS5518 / 8 ch PWM processor (AD, DAP, 192kHz, PWM-VOL) (TQFP64)	Texas Instruments	TAS5518PAG
1	U601	TLV272 / Dual RIR Output Opamp (VSSOP8)	Texas Instruments	TLV272CDGK

TAS5162DKD6EVM Partslist (2.00)



1	U600	SN74LVC2G126 / Dual Buffer, LVC (SSOP8)	Texas Instruments	SN74LVC2G126DCT
1	U904	TPS3825-33 / 3.3V Supply Voltage Supervisor (SOP5-DBV)	Texas Instruments	TPS3825-33DBVT
1	U900	UA78M12 / 12V/500mA Positive Voltage Regulator (PFM2-KTP)	Texas Instruments	UA78M12CKTPR
1	U901	TPS5430 / 5V/3A Buck Converter (HSOP8-DDA)	Texas Instruments	TPS5430DDA
1	U902	TPS76733 / 3.3V/1A Low Drop Voltage Regulator (HTSSOP20-PWP)	Texas Instruments	TPS76733QPWP
1	U903	TPS79133 / 3.3V/100mA Low Dropout Regulator (Ultra Low Noise) (SOP5-DBV)	Texas Instruments	TPS79133DBVR
4	SCREW620 SCREW621 SCREW622 SCREW623	M3x6 Pan Head, Pozidriv, A2 Screw	Bossard	BN 81882 M3x6
4	SCREW630 SCREW631 SCREW632 SCREW633	M3x10 Pan Head, Pozidriv, A2 Screw	Bossard	BN 81882 M3x10
4	WASHER620 WASHER621 WASHER622 WASHER623	M3 Stainless Steel Washer	Bossard	BN 670 M3
4	WASHER630 WASHER631 WASHER632 WASHER633	M3 Stainless Steel Spring Washer	Bossard	BN 760 M3
4	STANDOFF620 STANDOFF621 STANDOFF622 STANDOFF623	M3x10 Aluminium Stand-off	Ettinger	05.03.108
1	J902	5 pins / 1 row / 2.54mm Pitch Vertical Male Friction lock Pin header Header	Molex	22-27-2051
5	J101 J102 J103 J104 J112	2 pins / 1 row / 3.96mm Pitch Vertical Male Pin header Header	JST	B2P-VH
2	J900 J901	4 pins / 1 row / 3.96mm Pitch Vertical Male Pin header Header	JST	B4P-VH
1	J600	Horizontal Female w. Switch Coax Phono socket	Chunfeng	RJ843-4W
1	J60	16 pins / 2 rows / 2.54mm Pitch Vertical Male IDC 16 pins IDC Box header	Molex	87256-1611
1	J40	34 pins / 2 rows / 2.54mm Pitch Vertical Male IDC 34 pins IDC Box header	Molex	87256-3411
1	X10	13.5MHz 13.5MHz SMD Crystal (HCM49)	Citizen	HCM49-13.500MABJT
1	PCB610	A830-PCB-001_1.00 / TAS5162DKD6EVM Printed Circuit Board (ver. 1.00)	Printline	A830-PCB-001(1.00)
1	HEATSINK630	TIC-HSINK-051_1.00 / Heatsink for 3 DKD packages length 154mm	THF-Teknik	TIC-HSINK-051(1.00)

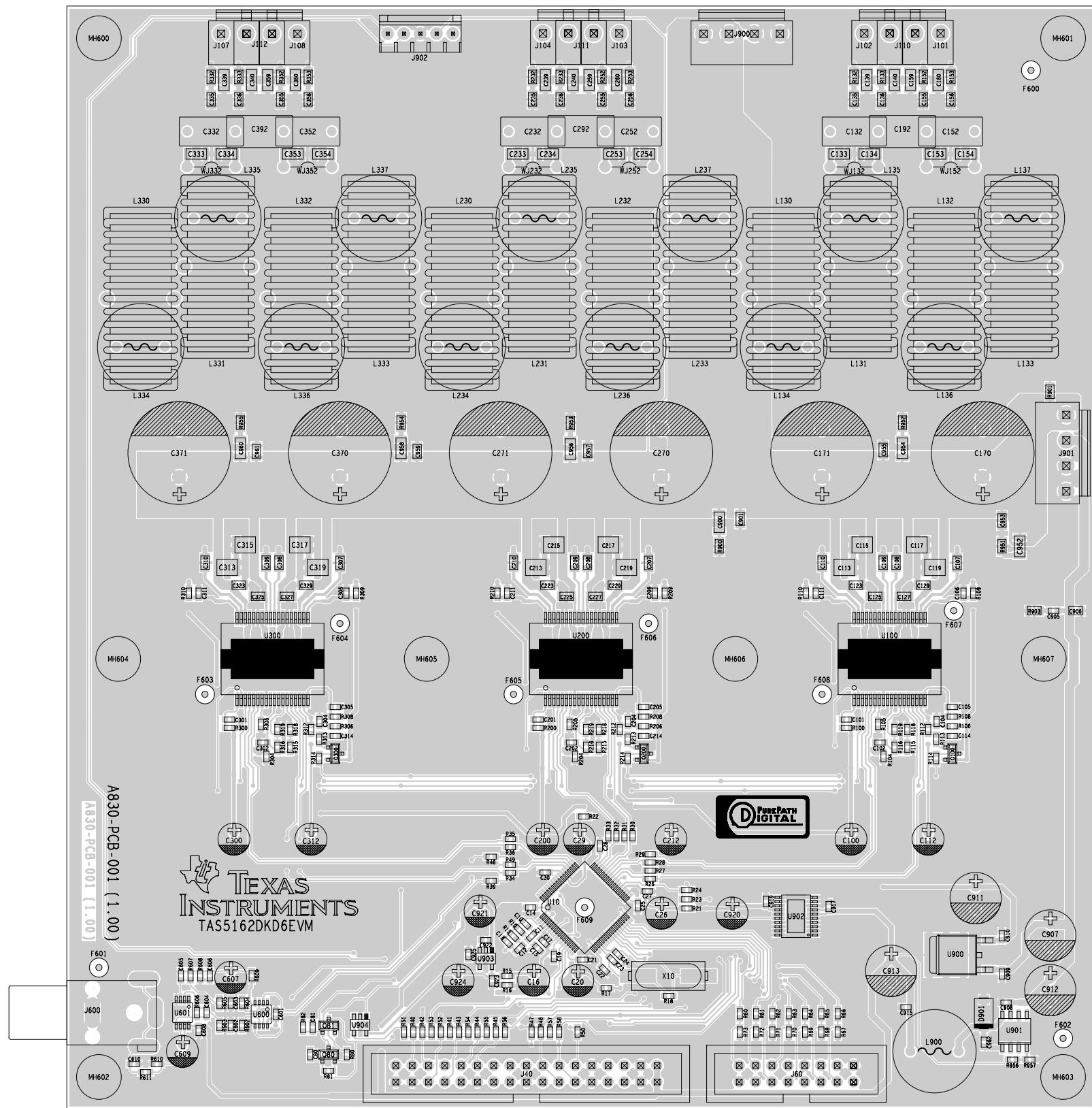
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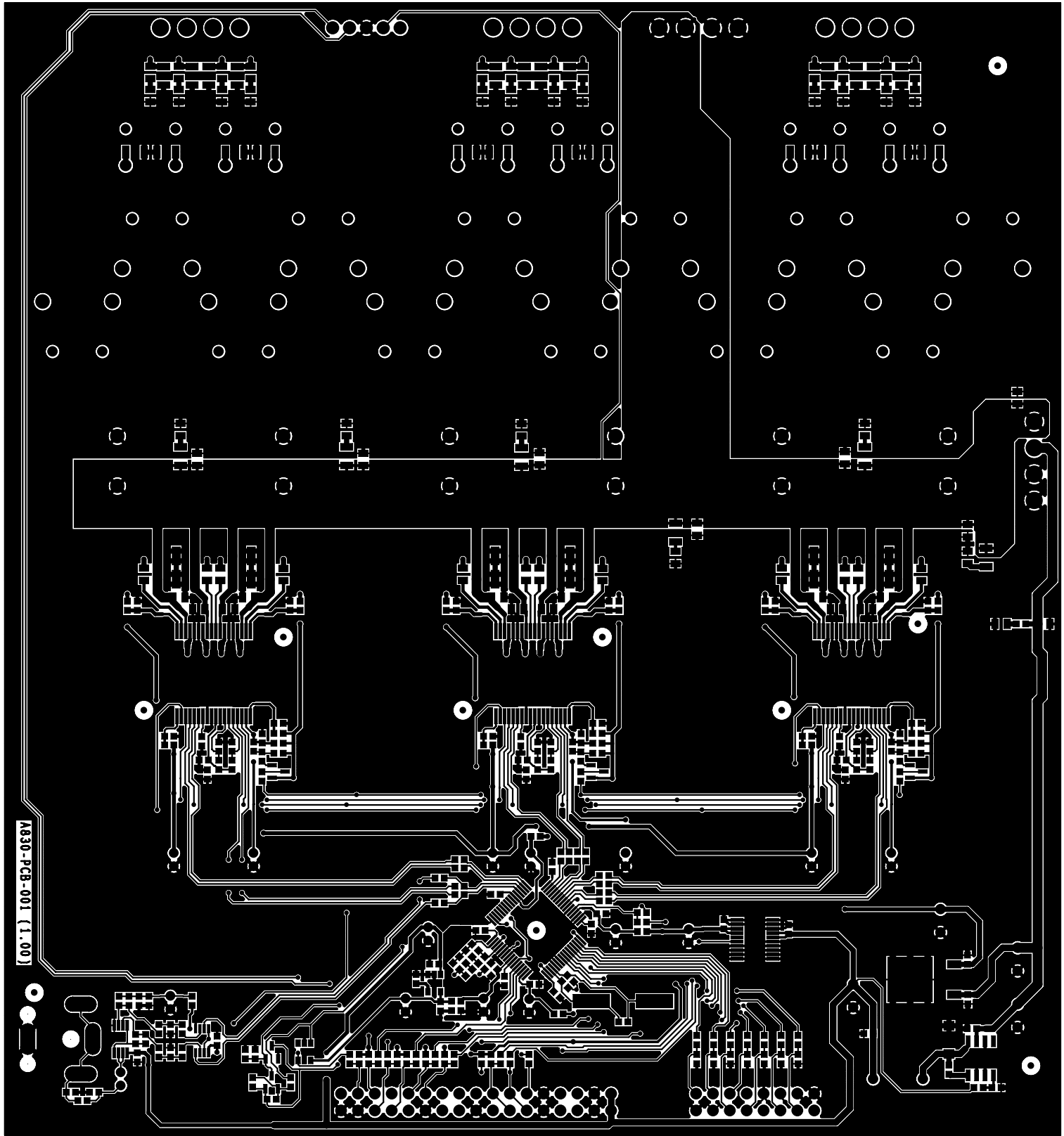
Version 1.00

BOARD IDENTIFICATION:	A830-PCB-001(1.00)
BOARD TYPE:	DOUBLE-SIDED PLATED-THROUGH BOARD
LAMINATE TYPE:	FR4
LAMINATE THICKNESS:	1.6mm
COPPER THICKNESS:	70 μ m (INCL. PLATING EXTERIOR LAYER)
COPPER PLATING OF HOLES:	>25 μ m
MINIMUM HOLE DIAMETER	0.3 mm
SILKSCREEN COMPONENT SIDE:	WHITE - REMOVE SILKSCREEN FROM SOLDER AREA & PRE-TINNED AREAS
SILKSCREEN SOLDER SIDE:	None
SOLDER MASK COMPONENT SIDE:	GREEN
SOLDER MASK SOLDER SIDE:	GREEN
PROTECTIVE COATING:	SOLDER COATING AND CHEMICAL SILVER ON FREE COPPER
ELECTRICAL TEST:	PCB MUST BE ELECTRICAL TESTED
MANUFACTURED TO:	PERFAG 2E (www.perfag.dk)
APERTURE TABLE:	PERFAG 10A (www.perfag.dk)
BOARD SIZE:	160 x 171.5 mm
Aprox. Number of holes	1200
COMMENTS:	SEE DRILL INFORMATION FILE (pdfdoc\FAB1_DRAWING.pdf).

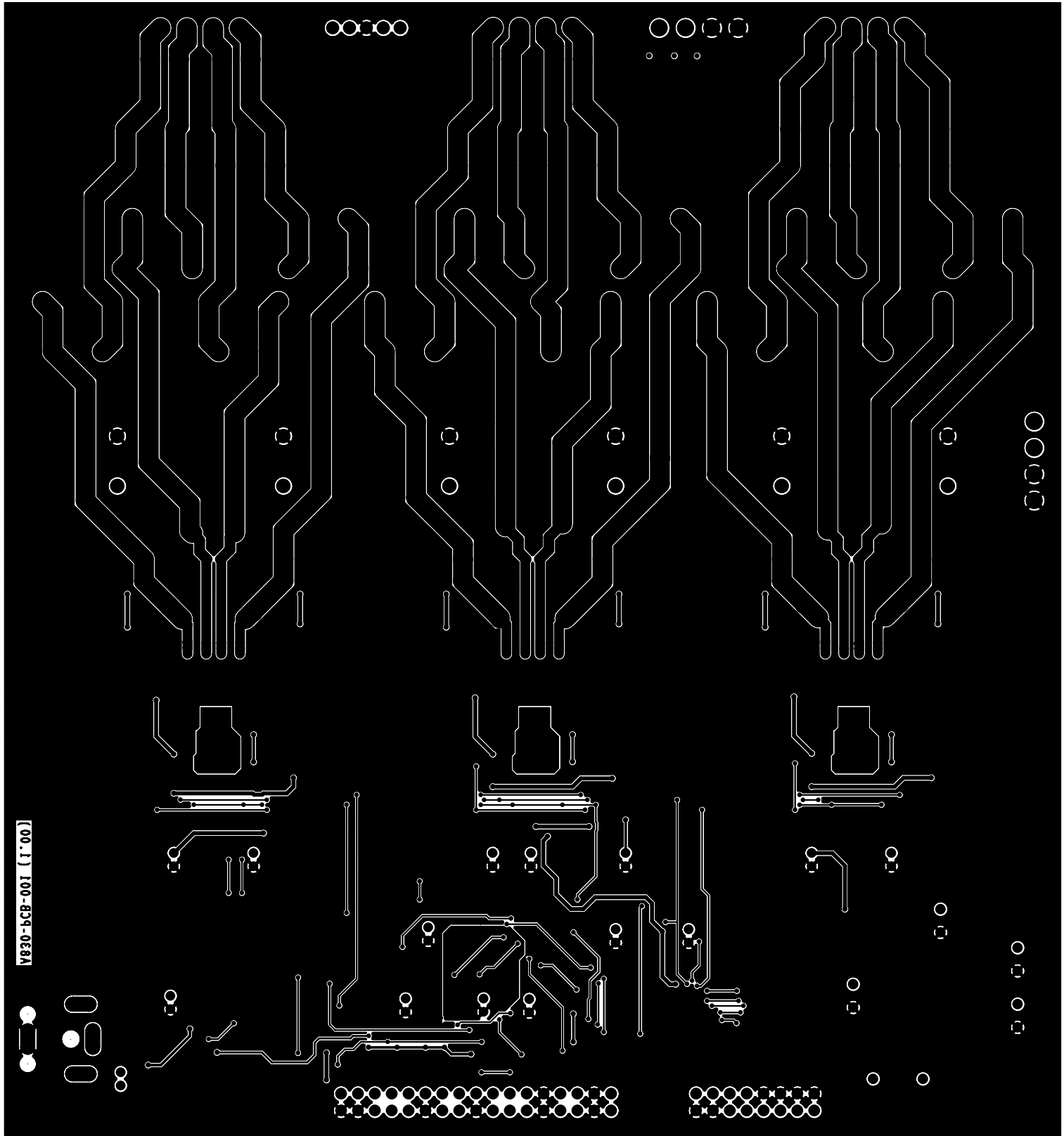
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	P/N A830-PCB-001-1-0	REV 0	Designer KR
	LAYER 01 - SHEET 01 OF 07	Engineer Jonas L. Holm	



POS	Texas Instruments Lyngby Hovedgade 4, DK-2800 Lyngby		
	Title TA55162DKD6EVM	Date 2007/MAJ/03	
	P/N A830-PCB-001-1-0	REV 0	Designer KR
	LAYER 01 - SHEET 01 OF 07	Engineer Jonas L. Holm	



POS	Texas Instruments Lyngby Hovedgade 4, DK-2800 Lyngby		
	Title TAS5162DKD6EVM	Date 2007/MAJ/03	
	P/N A830-PCB-001-1-0	REV 0	Designer KR
	LAYER 02 - SHEET 02 OF 07	Engineer Jonas L. Holm	

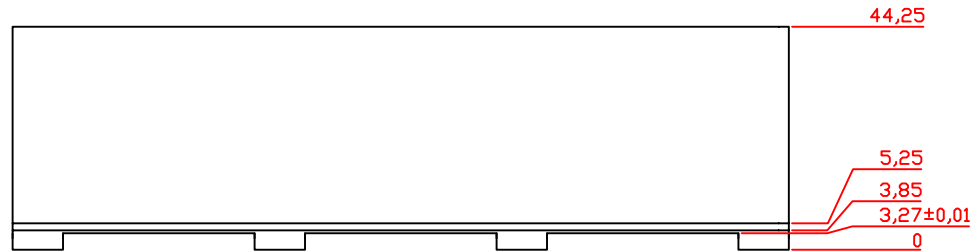
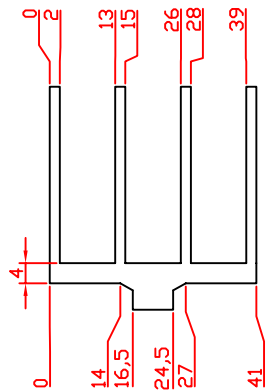
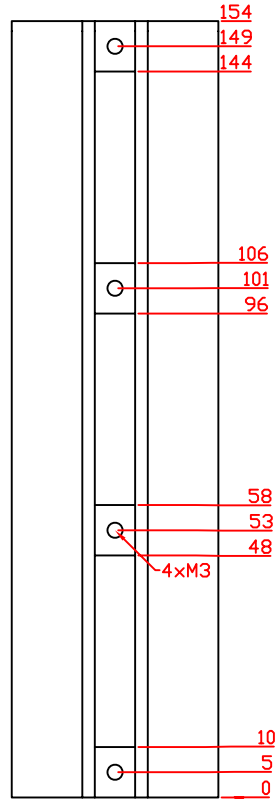


TIC-HSINK-051(1.00)

Heatsink for 3 DKD packages length 154 mm

2. May 2007
TIC-HSINK-051(1.00).dwg

Jonas L. Holm



SCALE: 1:1.5
PROFILE: TIC-HSINK-050 profile
DIMENSIONS: mm
MATERIAL: ALUMINUM
INTERNAL SCREW THREADS: M3
SURFACE: FREE OF SHARP EDGES
SURFACE TREATMENT: BLACK ANODIZED
TOLERANCES: +/- 0.1 mm

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 3.3 V to 5 V and the output voltage range of 0 V to 5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 30°C. The EVM is designed to operate properly with certain components above 85°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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